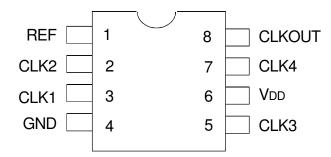
PIN CONFIGURATION



SOIC TOP VIEW

APPLICATIONS:

- SDRAM
- Telecom
- Datacom
- · PC Motherboards/Workstations
- Critical Path Delay Designs

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Rating	Max.	Unit
VDD	Supply Voltage Range	-0.5 to +4.6	V
VI ⁽²⁾	Input Voltage Range (REF)	-0.5 to +5.5	V
VI	Input Voltage Range	-0.5 to	V
	(except REF)	VDD+0.5	
IIK (VI < 0)	ıк (Vı < 0) Input Clamp Current		mA
Io (Vo = 0 to VDD)	Continuous Output Current	±50	mA
VDD or GND	Continuous Current	±100	mA
TA = 55°C	Maximum Power Dissipation	0.7	W
(in still air) ⁽³⁾			
Tstg	Storage Temperature Range	-65 to +150	°C
Operating	Commercial Temperature	0 to +70	°C
Temperature	Range		
Operating	Industrial Temperature	-40 to +85	°C
Temperature	Range		

NOTES:

- 1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

PIN DESCRIPTION

Pin Name	Pin Number	Туре	Functional Description
REF ⁽¹⁾	1	IN	Input reference clock, 5 Volt tolerant input
CLK2 ⁽²⁾	2	Out	Output clock
CLK1 ⁽²⁾	3	Out	Output clock
GND	4	Ground	Ground
CLK3 ⁽²⁾	5	Out	Output clock
VDD	6	PWR	3.3V Supply
CLK4 ⁽²⁾	7	Out	Output clock
CLKOUT ⁽²⁾	8	Out	Output clock, internal feedback on this pin

NOTES:

- 1. Weak pull down.
- 2. Weak pull down on all outputs.

OPERATING CONDITIONS - COMMERCIAL

Symbol	Parameter	Min.	Max.	Unit
VDD	Supply Voltage	3	3.6	V
TA	Operating Temperature (Ambient Temperature)	0	70	°C
CL	Load Capacitance < 100MHz	_	30	pF
	Load Capacitance 100MHz - 133MHz	_	10	
CIN	Input Capacitance	_	7	pF

DC ELECTRICAL CHARACTERISTICS - COMMERCIAL

Symbol	Parameter	С	onditions	Min.	Max.	Unit
VIL	Input LOW Voltage Level			_	0.8	V
Vih	Input HIGH Voltage Level			2	_	V
lıL	Input LOW Current	VIN = 0V		_	50	μA
lін	Input HIGH Current	VIN = VDD	VIN = VDD		100	μA
Vol	Output LOW Voltage	Standard Drive	IoL = 8mA	_	0.4	V
		High Drive	IoL = 12mA (-1H)			
Voн	Output HIGH Voltage	Standard Drive	Іон = -8mA	2.4	_	٧
		High Drive	Iон = -12mA (-1H)			
IDD_PD	Power Down Current	REF = 0MHz		_	12	μA
lod	Supply Current	Unloaded Outputs at 66.6	66MHz	_	32	mA

SWITCHING CHARACTERISTICS (23S05-1) - COMMERCIAL (1,2)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
tı	Output Frequency	10pFLoad	10	_	133	MHz
		30pFLoad	10	_	100	
	Duty Cycle = t2 ÷ t1	Measured at 1.4V, Fout = 66.66MHz	40	50	60	%
t3	Rise Time	Measured between 0.8V and 2V	_	_	2.5	ns
t4	FallTime	Measured between 0.8V and 2V	_	_	2.5	ns
t5	Output to Output Skew	All outputs equally loaded	_	-	250	ps
t6	Delay, REF Rising Edge to CLKOUT Rising Edge	Measured at VDD/2	_	0	±350	ps
t	Device-to-Device Skew	Measured at VDD/2 on the CLKOUT pins of devices	_	0	700	ps
tJ	Cycle-to-Cycle Jitter, pk - pk	Measured at 66.66MHz, loaded outputs	_	_	200	ps
tLOCK	PLL Lock Time	Stable power supply, valid clock presented on REF pin	_	_	1	ms

NOTES:

- 1. REF Input has a threshold voltage of VDD/2.
- 2. All parameters specified with loaded outputs.

SWITCHING CHARACTERISTICS (23S05-1H) - COMMERCIAL (1,2)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
tı	Output Frequency	10pFLoad	10	_	133	MHz
		30pFLoad	10	_	100	
	Duty Cycle = t2 ÷ t1	Measured at 1.4V, Fout = 66.66MHz	40	50	60	%
	Duty Cycle = t2 ÷ t1	Measured at 1.4V, Fout <50MHz	45	50	55	%
t3	Rise Time	Measured between 0.8V and 2V		_	1.5	ns
t4	Fall Time	Measured between 0.8V and 2V	_	_	1.5	ns
t5	Output to Output Skew	All outputs equally loaded	_	_	250	ps
t6	Delay, REF Rising Edge to CLKOUT Rising Edge	Measured at VDD/2	_	0	±350	ps
tr	Device-to-Device Skew	Measured at VDD/2 on the CLKOUT pins of devices	_	0	700	ps
t8	Output Slew Rate	Measured between 0.8V and 2V using Test Circuit #2	1	_	_	V/ns
tu	Cycle-to-Cycle Jitter, pk - pk	Measured at 66.66MHz, loaded outputs	_	_	200	ps
tlock	PLL Lock Time	Stable power supply, valid clock presented on REF pin	_	_	1	ms

NOTES:

- 1. REF Input has a threshold voltage of VDD/2.
- 2. All parameters specified with loaded outputs.

OPERATING CONDITIONS-INDUSTRIAL

Symbol	Parameter	Min.	Max.	Unit
VDD	Supply Voltage	3	3.6	V
TA	Operating Temperature (Ambient Temperature)	-40	+85	°C
CL	Load Capacitance < 100MHz	_	30	pF
	Load Capacitance 100MHz - 133MHz	_	10	
CIN	InputCapacitance	_	7	pF

DC ELECTRICAL CHARACTERISTICS - INDUSTRIAL

Symbol	Parameter	С	onditions	Min.	Max.	Unit
VIL	Input LOW Voltage Level			_	0.8	V
VIH	Input HIGH Voltage Level			2	_	V
lıL	Input LOW Current	VIN = 0V		_	50	μA
lін	Input HIGH Current	VIN = VDD		_	100	μΑ
Vol	Output LOW Voltage	Standard Drive	IoL = 8mA	_	0.4	V
		High Drive	IoL = 12mA (-1H)			
Voн	Output HIGH Voltage	Standard Drive	Iон = -8mA	2.4	_	V
		High Drive	Iон = -12mA (-1H)			
IDD_PD	Power Down Current	REF = 0MHz		_	25	μΑ
IDD	Supply Current	Unloaded Outputs at 66.	66MHz	_	35	mA

SWITCHING CHARACTERISTICS (23S05-1) - INDUSTRIAL (1,2)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
tı	Output Frequency	10pFLoad	10	_	133	MHz
		30pFLoad	10	_	100	
	Duty Cycle = t2 ÷ t1	Measured at 1.4V, FOUT = 66.66MHz	40	50	60	%
t3	Rise Time	Measured between 0.8V and 2V	_	_	2.5	ns
t4	FallTime	Measured between 0.8V and 2V	_	_	2.5	ns
t5	Output to Output Skew	All outputs equally loaded		_	250	ps
t6	Delay, REF Rising Edge to CLKOUT Rising Edge	Measured at VDD/2	_	0	±350	ps
t7	Device-to-Device Skew	Measured at VDD/2 on the CLKOUT pins of devices	_	0	700	ps
tı	Cycle-to-Cycle Jitter, pk - pk	Measured at 66.66MHz, loaded outputs	_	_	200	ps
tLOCK	PLL Lock Time	Stable power supply, valid clock presented on REF pin	_	_	1	ms

NOTES:

- 1. REF Input has a threshold voltage of VDD/2.
- 2. All parameters specified with loaded outputs.

SWITCHING CHARACTERISTICS (23S05-1H) - INDUSTRIAL (1,2)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
t1	Output Frequency	10pFLoad	10	_	133	MHz
		30pFLoad	10	_	100	
	Duty Cycle = t2 ÷ t1	Measured at 1.4V, Fout = 66.66MHz	40	50	60	%
	Duty Cycle = t2 ÷ t1	Measured at 1.4V, Fout <50MHz	45	50	55	%
t3	Rise Time	Measured between 0.8V and 2V	_	_	1.5	ns
t4	Fall Time	Measured between 0.8V and 2V	_	_	1.5	ns
t5	Output to Output Skew	All outputs equally loaded		_	250	ps
t6	Delay, REF Rising Edge to CLKOUT Rising Edge	Measured at VDD/2	_	0	±350	ps
t7	Device-to-Device Skew	Measured at VDD/2 on the CLKOUT pins of devices	_	0	700	ps
t8	Output Slew Rate	Measured between 0.8V and 2V using Test Circuit #2	1	_	_	V/ns
tu	Cycle-to-Cycle Jitter, pk - pk	Measured at 66.66MHz, loaded outputs	_	_	200	ps
tLOCK	PLL Lock Time	Stable power supply, valid clock presented on REF pin	_	_	1	ms

NOTES:

- 1. REF Input has a threshold voltage of VDD/2.
- 2. All parameters specified with loaded outputs.

ZERO DELAY AND SKEW CONTROL

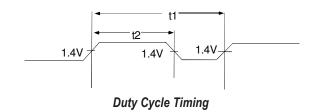
All outputs should be uniformly loaded in order to achieve Zero I/O Delay. Since the CLKOUT pin is the internal feedback for the PLL, its relative loading can affect and adjust the input/output delay.

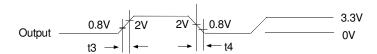
For designs utilizing zero I/O Delay, all outputs including CLKOUT must be equally loaded. Even if the output is not used, it must have a capacitive load equal to that on the other outputs in order to obtain true zero I/O Delay. If I/O Delay adjustments are needed, use the Output Load Difference diagram to calculate loading differences between the CLKOUT pin and other outputs. For zero output-to-output skew, all outputs must be loaded equally.

SPREAD SPECTRUM COMPATIBLE

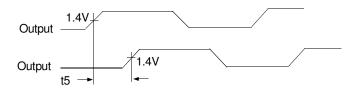
Many systems being designed now use a technology called Spread Spectrum Frequency Timing Generation. This product is designed not to filter off the Spread Spectrum feature of the reference input, assuming it exists. When a zero delay buffer is not designed to pass the Spread Spectrum feature through, the result is a significant amount of tracking skew, which may cause problems in systems requiring synchronization.

SWITCHING WAVEFORMS

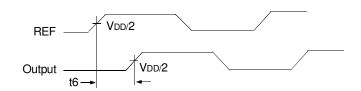




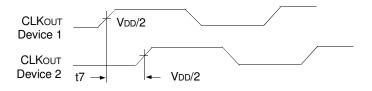
All Outputs Rise/Fall Time



Output to Output Skew

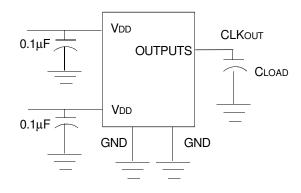


Input to Output Propagation Delay

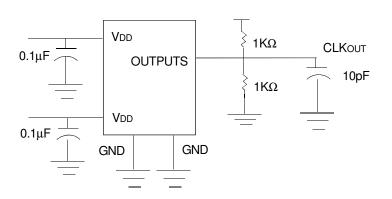


Device to Device Skew

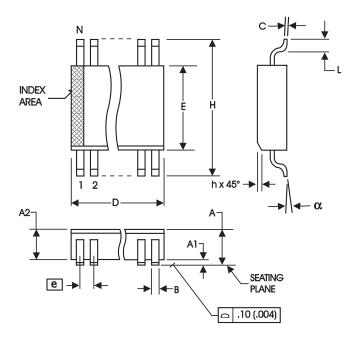
TEST CIRCUITS



Test Circuit 1 (all Parameters Except t8)



Test Circuit 2 (t8, Output Slew Rate On -1H Devices)



150 mil (Narrow Body) SOIC

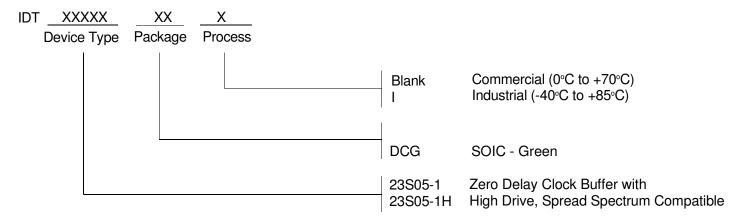
	In Milli	meters	In Inches				
SYMBOL	COMMON D	IMENSIONS	COMMON DIMENSIONS				
	MIN	MAX	MIN	MAX			
Α	1.35	1.75	.0532	.0688			
A1	0.10	0.25	.0040	.0098			
В	0.33	0.51	.013	.020			
С	0.19	0.25	.0075	.0098			
D	SEE VAF	RIATIONS	SEE VARIATIONS				
E	3.80	4.00	.1497	.1574			
е	1.27 BASIC		0.050	BASIC			
Н	5.80	6.20	.2284	.2440			
h	0.25	0.50	.010	.020			
L	0.40	1.27	.016 .050				
N	SEE VAF	RIATIONS	SEE VAF	RIATIONS			
а	0°	8°	0°	8°			

VARIATIONS

N	Dn	nm.	D (inch)		
	MIN	MAX	MIN	MAX	
8	4.80	5.00	.1890	.1968	

Reference Doc.: JEDEC Publication 95, MS-012

ORDERING INFORMATION



Part / Order Number	Shipping Packaging	Package	Temperature
23S05-1DCG	Tubes	8-pin SOIC	0° to +70° C
23S05-1DCG8	Tape and Reel	8-pin SOIC	0° to +70° C
23S05-1DCGI	Tubes	8-pin SOIC	-40° to +85°C
23S05-1DCGI8	Tape and Reel	8-pin SOIC	-40° to +85°C
23S05-1HDCG	Tubes	8-pin SOIC	0° to +70° C
23S05-1HDCG8	Tape and Reel	8-pin SOIC	0° to +70° C
23S05-1HDCGI	Tubes	8-pin SOIC	-40° to +85°C
23S05-1HDCGI8	Tape and Reel	8-pin SOIC	-40° to +85°C

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